

VDP Multiple Pixel Clock Generator

Features

- Generates multiple clock outputs from 20MHz external reference clock
- Input frequency: 20MHz
- Output frequencies:
 - Selectable CLKOUT:108MHz, 27MHz, 33.2MHz, 85MHz, 65MHz,25MHz, 45MHz, and 40MHz
 - o REFOUT: 20MHz
- Operating Supply Voltage: 3.3V ± 0.3V
- Zero ppm frequency synthesis error on all clock outputs
- 8-pin SOIC package

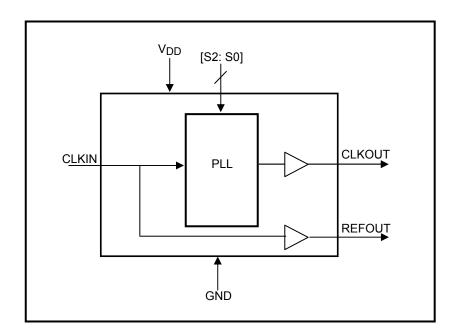
Product Description

The PCS1P2192A is a clock generator that generates multiple selectable pixel clock outputs for Video Display Panel applications from an external 20MHz reference clock. The PLL based clock generator is specifically designed to provide zero ppm frequency synthesis error on all clock outputs. Various pixel clock rates are selectable through frequency selection pins S[2:0] (Refer to $Frequency\ Selection\ Table)$ The device provides a reference clock output additionally. Operating Supply Voltage for this device is 3.3V \pm 0.3V. The device is available in an 8-pin SOIC package.

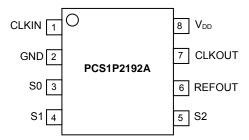
Application

PCS1P2192A is targeted towards Video Display Panel (VDP) applications like VGA, SVGA, XGA, WXGA, UXGA.

Block Diagram



Pin Configuration



Pin Description

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Pin#	Pin Name	Туре	Description		
1	CLKIN	1	20MHz external reference clock input.		
2	GND	Р	Ground Connection.		
3	S0	I	Frequency select. Digital logic input used to select output frequency. Has an internal pull up resistor. (Refer to Frequency Selection Table.)		
4	S1	I	Frequency select. Digital logic input used to select output frequency. Has an internal pull up resistor. (Refer to <i>Frequency Selection Table</i> .)		
5	S2	1	Frequency select. Digital logic input used to select output frequency. Has an internal pull up resistor. (Refer to <i>Frequency Selection Table</i> .)		
6	REFOUT	0	Reference clock output.		
7	CLKOUT	0	Clock output.		
8	V_{DD}	Р	Device Power Supply .		

Frequency Selection Table

S2	S1	S0	CLKOUT (MHz)
0	0	0	108
0	0	1	27
0	1	0	33.2
0	1	1	85
1	0	0	65
1	0	1	25
1	1	0	45
1	1	1	40

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit			
V_{DD},V_{IN}	Voltage on any input pin with respect to Ground	-0.5 to +4.6	V			
T _{STG}	Storage temperature	-65 to +125	ဗ			
Ts	Max. Soldering Temperature (10 sec)	260	C			
TJ	Junction Temperature	150	$^{\circ}$			
T _{DV} Static Discharge Voltage 2 KV (As per JEDEC STD22- A114-B)						
Note: These are stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.						

Recommended Operating Conditions

Parameter	Description	Min	Тур	Max	Unit
V_{DD}	Operating Voltage	3.0	3.3	3.6	V
T _A	Operating Temperature	0		+85	${\mathfrak C}$
C_L	Load Capacitance			15	pF
C _{IN}	Input Capacitance			7	pF

DC Electrical Characteristics

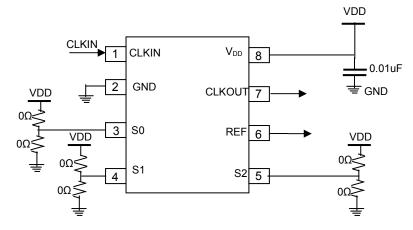
Symbol	Parameter	Min	Тур	Max	Unit
V_{IL}	Input low voltage (For CLKIN)	GND-0.3		0.8	V
V _{IH}	Input high voltage (For CLKIN)	2.0		VDD+0.3	V
I _{IL}	Input low current			50	μA
I _{IH}	Input high current			-50	μA
V _{OL}	Output low voltage (VDD = 3.3V, I _{OL} = 8mA)			0.4	V
V _{OH}	Output high voltage (VDD = 3.3V, I _{OH} = -8mA)	2.4			V
I _{DD}	Static supply current ¹			5	mA
Icc	Dynamic supply current (3.3V and no load)		9		mA
V_{DD}	Operating Voltage	3.0	3.3	3.6	V
t _{ON}	Power-up time (first locked cycle after power-up)		1		mS
Z _{OUT}	Output impedance		40		Ω
Note: 1. CLKIN pulled low.					

PCS1P2192A

AC Electrical Characteristics

Symbol	Parameter	Min	Тур	Max	Unit	
f _{IN}	Input frequency		20		MHz	
f _{OUT}	Output frequency		108, 27, 33.2, 85, 65, 25, 45, 40		MHz	
t _{LH} ¹	Output rise time (Measured from 20% to 80%)	1.2		2.5	nS	
t _{HL} 1	Output fall time (Measured from 80% to 20%)	0.8		1.6	nS	
t _{JC}	Period Jitter		±150		pS	
	Frequency Synthesis Error (All Outputs)		0		ppm	
t _D	Output duty cycle		50	60	%	
Note: 1. Measured with a capacitive load of 15pF.						

Typical Application Schematic



Use either pull-up or pull-down 0Ω Resistor with [S2:S0] for selection of CLKOUT frequencies.

PCB Layout Recommendation

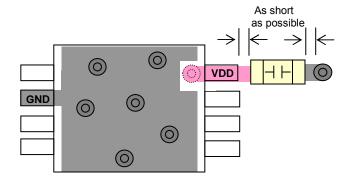
For optimum device performance, following guidelines are recommended.

- Dedicated VDD and GND planes.
- The device must be isolated from system power supply noise. A 0.01µF decoupling capacitor should be mounted on the component side of the board as close to the VDD pin as possible. No vias should be

used between the decoupling capacitor and VDD pin. The PCB trace to VDD pin and the ground via should be kept as short as possible. All the VDD pins should have decoupling capacitors.

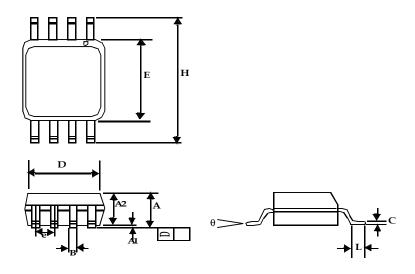
 In an optimum layout all components are on the same side of the board, minimizing vias through other signal layers.

A typical layout is shown in the figure below.



Package Information

8-Pin SOIC Package



	Dimensions				
Symbol	Inc	hes	Millimeters		
	Min	Max	Min	Max	
A1	0.004	0.010	0.10	0.25	
Α	0.053	0.069	1.35	1.75	
A2	0.049	0.059	1.25	1.50	
В	0.012	0.020	0.31	0.51	
С	C 0.007 0.010		0.18	0.25	
D	0.193 BSC		4.90 BSC		
Е	0.154	0.154 BSC		BSC	
е	0.050 BSC		1.27 BSC		
Н	0.236 BSC		6.00	BSC	
L	0.016	0.050	0.41	1.27	
θ	0°	8°	0°	8°	

PCS1P2192A

Ordering Code

Part Number	Marking	Package Type	Temperature
PCS1P2192AG-08SR	ACZ	8-Pin SOIC, TAPE & REEL, Green	0℃ to +85℃

A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-free.

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